

S/N 09/650,566

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

~~Applicant:~~ Kishore K. Chakravorty et al.

Examiner: Thanh S. Phan

~~Serial No.:~~ 09/650,566

Group Art Unit: 2841

~~Filed:~~ August 30, 2000

Docket: 884.315US1

~~Title:~~ ELECTRONIC ASSEMBLY COMPRISING CERAMIC/ORGANIC HYBRID
SUBSTRATE WITH EMBEDDED CAPACITORS AND METHODS OF
MANUFACTURE



AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents
Washington, D.C. 20231

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R. Tyson
8/24/02
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Applicants have reviewed the Office Action mailed on May 8, 2002. Please amend the above-identified patent application as follows.

IN THE CLAIMS

Please substitute the claim set in the appendix entitled "Clean Version of Pending Claims" for the previously pending claim set. The substitute claim set is intended to reflect amendment of previously pending claims 3, 5-6, 28 and 30, and the addition of new claims 31-40. Claims 1-10 and 28-40 are pending in this application. The specific amendments to individual claims are detailed in the following marked up set of claims.

3. (Amended) The multilayer substrate recited in claim 2, wherein the pitch of the second plurality of lands is greater than the pitch of the first plurality of lands, and wherein the pitch is increased within the organic portion [layer].

5. (Amended) The multilayer substrate recited in claim 4, wherein the pitch of the second plurality of lands is greater than the pitch of the first plurality of lands, and wherein the pitch is increased within the organic portion [layer].

6. (Twice Amended) The multilayer substrate recited in claim 2, wherein the third and fourth lands are positioned to couple to corresponding power supply nodes of an additional substrate underlying [subjacent to] the multilayer [ceramic] substrate.